

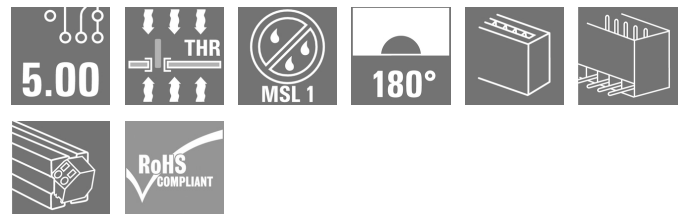
MHS 5/10 V T3 B T**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image**OMNIMATE® 4.0 - the next evolution step**

OMNIMATE® 4.0 follows the trend of One Cable Technology (OCT). The modular concept enables the fast configuration of hybrid interfaces, which transmit data, signals and energy in a single connector. As a result, you can reduce the cabling effort in a wide variety of applications, simplify maintenance and accelerate automation processes. The unique SNAP IN connection is the backbone and speeds up the wiring process.

The fastest connection yet

- Fast, safe, and tool-free wiring due to unique SNAP IN connection
- Ready for Robot through "wire ready" delivery with open clamping point
- Optical and acoustic feedback indicates proper wiring

Create your own configuration

- Flexible configuration and ordering via the Weidmüller Configurator (WMC)
- Dispatch within three days – even for individually configured products
- Automatic offer preparation for the configured product

Simply configuration of modular hybrid connectors

- Flexible combination options for power, signal and data transmission
- Future-proof Single-Pair Ethernet technology

General ordering data

Version	PCB plug-in connector, male header, THT/THR solder connection, Pitch in mm (P): 5.00 mm, Number of poles: 10, 180°, Tube
Order No.	8000072456
Type	MHS 5/10 V T3 B T
GTIN (EAN)	4064675423201
Qty.	10 pc(s).
Product data	IEC: 400 V / 25.3 A UL: 300 V / 18.5 A
Packaging	Tube

MHS 5/10 V T3 B T

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Technical data

Dimensions and weights

Depth	11.9 mm	Depth (inches)	0.469 inch
Height	17.2 mm	Height (inches)	0.677 inch
Height of lowest version	14 mm	Width	51.38 mm
Width (inches)	2.023 inch	Net weight	6.463 g

Temperatures

Ambient temperature	-50 °C...125 °C
---------------------	-----------------

System specifications

Product family	OMNIMATE 4.0	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	5 mm
Pitch in inches (P)	0.197 "	Outgoing elbow	180°
Number of poles	10	Number of solder pins per pole	1
Solder pin length (l)	3.2 mm	Solder pin dimensions	1.0 x 1.0 mm
Solder eyelet hole diameter (D)	1.4 mm	Solder eyelet hole diameter tolerance (D)+ 0,1 mm	
Outside diameter of solder pad	2.3 mm	Template aperture diameter	2.1 mm
L1 in mm	45 mm	L1 in inches	1.772 "
Number of rows	1	Pin series quantity	1
Touch-safe protection acc. to DIN VDE 57 106	Touch-safe above the printed circuit board	Touch-safe protection acc. to DIN VDE 0470	IP 20
Protection degree	IP20	Volume resistance	≤5 mΩ
Plugging cycles	≥ 25	Plugging force/pole, max.	8.5 N
Pulling force/pole, max.	8.5 N		

Material data

Insulating material	PA 9T	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	I
Comparative Tracking Index (CTI)	≥ 600	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact base material	CuMg
Contact material	Cu-alloy	Contact surface	tinned
Tinning type	matt	Storage temperature, min.	-25 °C
Storage temperature, max.	55 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	25.3 A
Rated current, max. number of poles (Tu=20°C)	20.8 A	Rated current, min. number of poles (Tu=40°C)	21.8 A
Rated current, max. number of poles (Tu=40°C)	18 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV	Clearance, min.	4 mm
Creepage distance, min.	5.4 mm		

MHS 5/10 V T3 B T

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Technical data

Rated data acc. to UL 1059

Institute (cURus)



Certificate No. (cURus)

E60693

Rated voltage (Use group B / UL 1059) 300 V

Rated voltage (Use group D / UL 1059) 300 V

Rated voltage (Use group F / UL 1059) 420 V

Rated current (Use group B / UL 1059) 18.5 A

Rated current (Use group D / UL 1059) 10 A

Clearance distance, min. 4 mm

Creepage distance, min.

Reference to approval values

Specifications are maximum values, details - see approval certificate.

5.6 mm

Classifications

ETIM 6.0

EC002637

ETIM 7.0

EC002637

ETIM 8.0

EC002637

ETIM 9.0

EC002637

ETIM 10.0

EC002637

ECLASS 9.0

27-44-04-02

ECLASS 9.1

27-44-04-02

ECLASS 10.0

27-44-04-02

ECLASS 11.0

27-46-02-01

ECLASS 12.0

27-46-02-01

ECLASS 13.0

27-46-02-01

ECLASS 14.0

27-46-02-01

ECLASS 15.0

27-46-02-01

Environmental Product Compliance

RoHS Compliance Status

Compliant without exemption

REACH SVHC

No SVHC above 0.1 wt%

Important note

IPC conformity

Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- Rated current related to rated cross-section & min. No. of poles.
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Diameter of solder eyelet D = 1.4+0.1mm
- In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC). During designated use, connectors are not allowed to be engaged or disengaged when live or under load
- Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

MHS 5/10 V T3 B T**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com**Technical data****Approvals**

Approvals



Approvals MAMID	https://mdcop.weidmueller.com/mediadelivery/rendition/900_319230/-T1z1mm-S800/
ROHS	Conform
UL File Number Search	UL Website
Certificate No. (cURus)	E60693

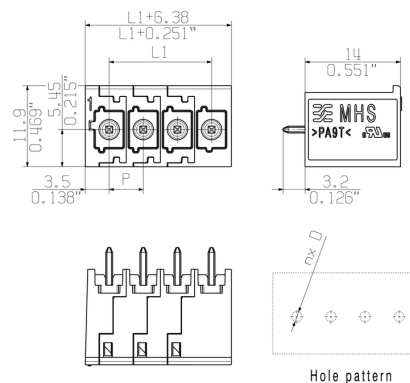
Downloads

Approval/Certificate/Document of Conformity	CoC_cURus_E60693_MPS_MHS_202207.pdf Declaration of the Manufacturer
Engineering Data	CAD data – STEP
Catalogues	Catalogues in PDF-format

MHS 5/10 V T3 B T

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 26
D-32758 Detmold
Germany

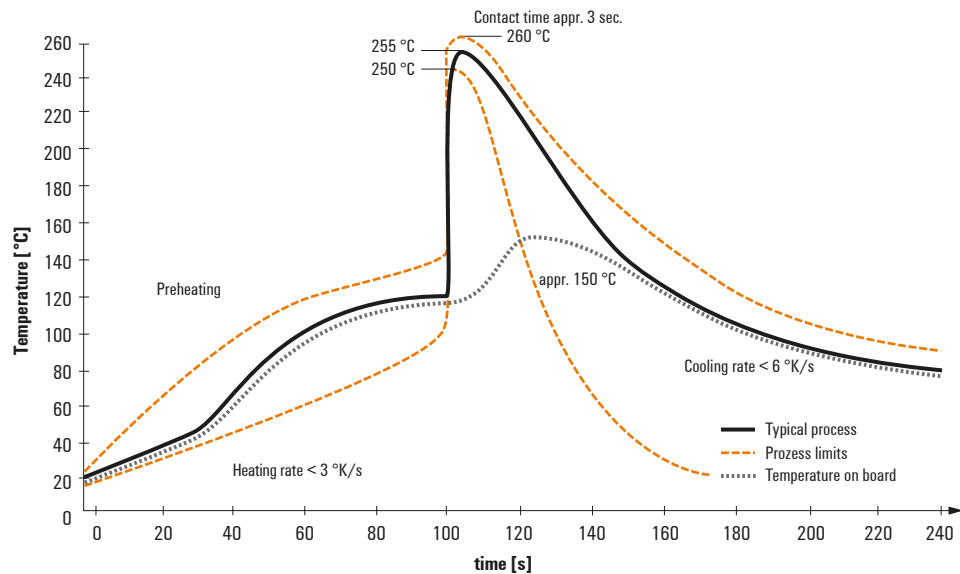
www.weidmueller.com

Drawings**Product image****Dimensional drawing**

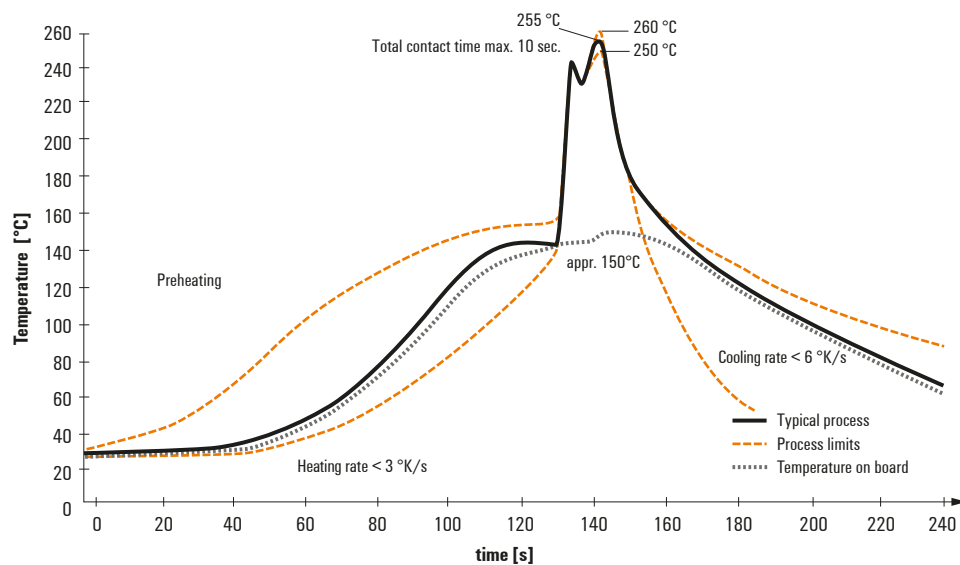
Recommended wave soldering profiles

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

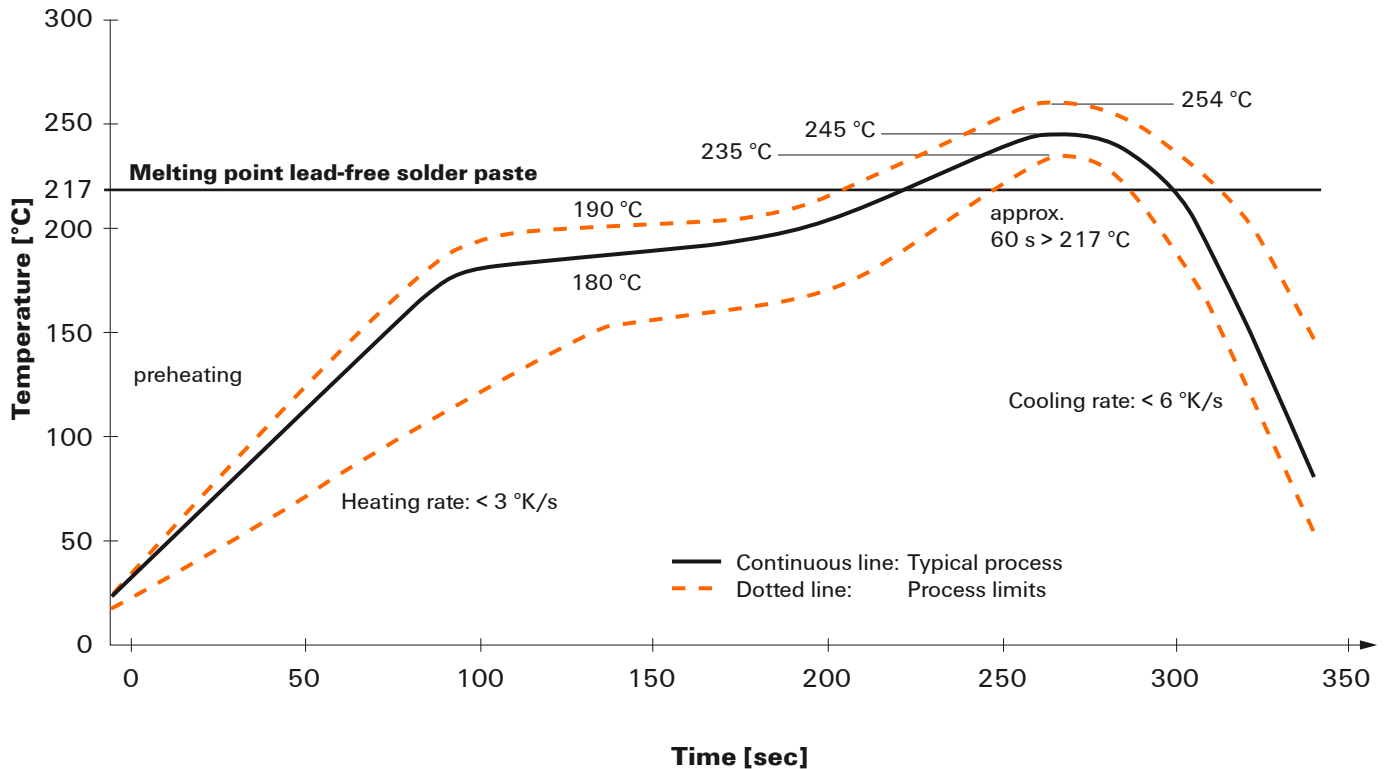
- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com



Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.